



**IEEE International Symposium on  
Product Compliance Engineering-Asia  
2020  
(ISPCE-CN 2020)**

ISPCE-CN 2020

IEEE International Symposium on Product Compliance  
Engineering-Asia

Dear \_\_\_\_\_,

*Friday,  
November  
6<sup>th</sup>, 2020*

### Invitation Letter

On behalf of the conference organizing committee, I would like to invite you to attend and present your research work on 2020 IEEE International Symposium on Product Compliance Engineering-Asia (*ISPCE-CN 2020*). *ISPCE-CN 2020* will be held on 6-8 November, 2020 in Chongqing & Hong Kong, China (the main stream has changed to a virtual conference due to COVID-19). This conference will provide a forum for technical presentations and discussions among all attendees.

All attendees will be responsible for funding their attendance. Should you have any questions, please contact the organization committee of ISPCE-CN 2020 by email at [ispce\\_cn2020@163.com](mailto:ispce_cn2020@163.com). We look forward to meeting you in a virtual IEEE ISPCE-CN 2020.

Yours sincerely,

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